



EUROPEAN SPACE AGENCY

ELEVATING THE FUTURE OF EUROPE

Systronic
Att. Mr. R. Faure
6 Avenue Atlantique
91940 Ullis (Les) France

Our ref: ESA-TECMSP-LE-2026-002831

VISA : T. Rohr (TEC-MSP)

 Digitally signed
by Thomas Rohr
Date: 2026.10.05
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Noordwijk, 08/09/2026

SUBJECT: NON-SEQUENTIAL RIGID EPOXY HTG PCB QUALIFICATION RENEWAL

Dear Mr. Faure,

Systronic submitted a non-sequential rigid epoxy HTg PCB to ESA for qualification renewal in July 2026. The qualification results are reported in ESA-TECMSP-TR-2026-002676. No Deviations from the applicable requirements were identified during the inspection of the qualification board.

Systronic is therefore considered qualified in accordance with ECSS-Q-ST-70-60C for the manufacture of printed circuit boards within the qualification domain defined by the following Process Identification Document (PID).

- Non sequential rigid epoxy HTg PCB as defined in PID1 edition 13, until 01 September 2028

Best regards,

Simon
Fidder
Simon Fidder

 Digitally signed
by Simon Fidder
Date: 2026.09.08
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Material, Manufacturing and Assembly section TEC-MSP